



these non-patent references on the attached form PTO-1449 and enclosing copies of the references. Each of these non-patent references was discussed in an attachment to the May 8 Information Disclosure Statement, and the Examiner's attention is directed to that attachment for an indication of the relevance of each of these listed non-patent references. Applicant would like to expressly note that a substantial number of the non-patent references are clearly not prior art to this application. However, in the spirit of full disclosure, applicant has nevertheless cited all of the references cited in the '273 application.

Signed at Chicago, in the County of Cook and State of Illinois this 20th day of November, 1987.

Respectfully submitted,

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CERTIFICATE OF MAILING

I hereby certify that this Supplemental Information Disclosure Statement is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on this 20th day of November, 1987.

By

*John B. Conklin*

Dated:

*Nov. 20, 1987*